

# DATA SHEET

## SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

High-Voltage

NP0/X7R

1 KV TO 3 KV

10 pF to 33 nF

RoHS compliant & Halogen Free



SCOPE

This specification describes High-Voltage NP0/X7R series chip capacitors with lead-free terminations.

APPLICATIONS

PCs, Hard disk, Game PCs  
Power supplies  
LCD panel  
ADSL, Modem

FEATURES

Supplied in tape on reel  
Nickel-barrier end termination  
RoHS compliant  
Halogen Free compliant

ORDERING INFORMATION - GLOBAL PART NUMBER, PHYCOMP

CTC & I2NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

**YAGEO BRAND ordering code**

**GLOBAL PART NUMBER (PREFERRED)**

**CC** XXXX X X XXX X **B** X XXX  
(1) (2) (3) (4) (5) (6) (7)

**(1) SIZE – INCH BASED (METRIC)**

0805 (2012) / 1206 (3216) / 1210 (3225) / 1808 (4520) / 1812 (4532)

**(2) TOLERANCE**

C = ±0.25 pF  
D = ±0.5 pF  
G = ±2%  
J = ±5%  
K = ±10%

**(3) PACKING STYLE**

R = Paper/PE taping reel; Reel 7 inch  
K = Blister taping reel; Reel 7 inch  
P = Paper/PE taping reel; Reel 13 inch  
F = Blister taping reel; Reel 13 inch  
C = Bulk case

**(4) TC MATERIAL**

NPO  
X7R

**(5) RATED VOLTAGE**

C = 1 KV  
D = 2 KV  
S = 2.5KV  
E = 3 KV

**(6) PROCESS**

N = NP0  
B = Class 2 MLCC

**(7) CAPACITANCE VALUE**

2 significant digits+number of zeros  
The 3rd digit signifies the multiplying factor, and letter R is decimal point  
Example: 121 = 12 × 10<sup>1</sup> = 120 pF

**CONSTRUCTION**

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

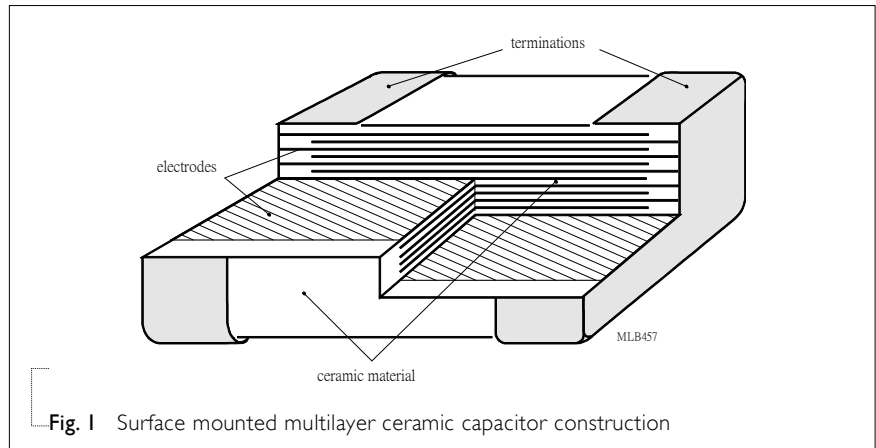


Fig. 1 Surface mounted multilayer ceramic capacitor construction

**DIMENSION**

Table I For outlines see fig. 2

TYPE	L <sub>1</sub> (mm)	W (mm)	T (MM)	L <sub>2</sub> / L <sub>3</sub> (mm)		L <sub>4</sub> (mm)
				min.	max.	min.
0805	2.0 ±0.20	1.25 ±0.20	Refer to table 2 to 4	0.25	0.75	0.55
1206	3.2 ±0.30	1.6 ±0.20		0.25	0.75	1.40
1210	3.2 ±0.30	2.5 ±0.20		0.25	0.75	1.40
1808	4.5 ±0.40	2.0 ±0.30		0.25	0.75	2.20
1812	4.5 ±0.40	3.2 ±0.20		0.25	0.75	2.20

**OUTLINES**

For dimension see Table I

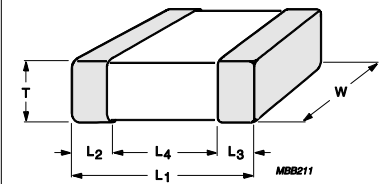


Fig. 2 Surface mounted multilayer ceramic capacitor dimension

**CAPACITANCE RANGE & THICKNESS FOR NP0**

**Table 2** Sizes from 0805 to 1812

CAP.	0805		1206		1210		1808			1812		
	1 KV	1 KV	2 KV	1 KV	2 KV	1 KV	2 KV	3 KV	1 KV	2 KV	3 KV	
10 pF	0.85±0.1	1.25±0.2	1.25±0.2					1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
12 pF	0.85±0.1	1.25±0.2	1.25±0.2					1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
15 pF	0.85±0.1	1.25±0.2	1.25±0.2					1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
18 pF	0.85±0.1	1.25±0.2	1.25±0.2					1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
22 pF	0.85±0.1	1.25±0.2	1.25±0.2					1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
27 pF	0.85±0.1	1.25±0.2	1.25±0.2					1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
33 pF	0.85±0.1	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
39 pF	0.85±0.1	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
47 pF	0.85±0.1	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
56 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
68 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
82 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
100 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
120 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
150 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
180 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	2.0±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
220 pF		1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	2.0±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
270 pF		1.25±0.2		1.25±0.2		1.25±0.2	1.25±0.2		1.25±0.2	1.25±0.2		
330 pF		1.25±0.2		1.25±0.2		1.25±0.2	1.25±0.2		1.25±0.2			
390 pF		1.25±0.2		1.25±0.2		1.25±0.2	1.25±0.2		1.25±0.2			
470 pF		1.25±0.2		1.25±0.2		1.25±0.2	1.25±0.2		1.25±0.2			
560 pF		1.25±0.2		1.25±0.2		1.25±0.2	1.25±0.2		1.25±0.2			
680 pF		1.25±0.2		1.25±0.2		1.25±0.2			1.25±0.2			
820 pF		1.25±0.2		1.25±0.2		1.25±0.2			1.25±0.2			
1.0 nF		1.25±0.2		1.25±0.2		2.0±0.2			1.25±0.2			
1.2 nF									1.25±0.2			
1.5 nF									1.25±0.2			
1.8 nF												
2.2 nF												
2.7 nF												
3.3 nF												

**NOTE**

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-12 series is on request

**CAPACITANCE RANGE & THICKNESS FOR X7R**

**Table 3** Sizes from 0805 to 1812

CAP.	0805		1206		1210		1808			1812		
	1 KV	1 KV	2 KV	2.5KV	1 KV	2 KV	1 KV	2 KV	3 KV	1 KV	2 KV	3 KV
100 pF												
150 pF	0.85±0.1								1.6±0.2			
220 pF	0.85±0.1	1.25±0.2	1.25±0.2		1.25±0.2	1.25±0.2			1.6±0.2			
330 pF	0.85±0.1	1.25±0.2	1.25±0.2		1.25±0.2	1.25±0.2		1.35±0.15	1.6±0.2			
470 pF	0.85±0.1	1.25±0.2	1.25±0.2		1.25±0.2	1.25±0.2	1.35±0.15	1.35±0.15	1.6±0.2			
680 pF	0.85±0.1	1.25±0.2	1.25±0.2		1.25±0.2	1.25±0.2	1.35±0.15	1.35±0.15	1.6±0.2			
1.0 nF	0.85±0.1	1.25±0.2	1.25±0.2	1.6±0.2	1.25±0.2	1.25±0.2	1.35±0.15	1.35±0.15	2.0±0.2	1.35±0.15	1.35±0.15	1.6±0.2
1.5 nF		1.25±0.2	1.25±0.2		1.25±0.2	1.25±0.2	1.35±0.15	1.35±0.15	2.0±0.2	1.35±0.15	1.35±0.15	
2.2 nF		1.25±0.2			1.25±0.2	1.60±0.2	1.35±0.15	1.6±0.2		1.35±0.15	1.35±0.15	
3.3 nF		1.25±0.2			1.25±0.2		1.35±0.15			1.35±0.15	1.35±0.15	
4.7 nF		1.25±0.2			1.25±0.2		1.35±0.15			1.35±0.15	1.35±0.15	
6.8 nF		1.25±0.2			1.25±0.2		1.6±0.2			1.35±0.15	1.6±0.2	
10 nF		1.25±0.2			1.25±0.2		1.6±0.2			1.35±0.15	2.0±0.2	
15 nF					1.25±0.2					1.35±0.15		
22 nF					1.6±0.2					1.35±0.15		
33 nF										1.6±0.2		
47 nF												
68 nF												
100 nF												

**NOTE**

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-6 series is on request
3. For products with 5% tolerance, please contact local sales force before ordering

**THICKNESS CLASSES AND PACKING QUANTITY**

Table 5

SIZE CODE	THICKNESS CLASSIFICATION	TAPE WIDTH QUANTITY PER REEL	Ø180 MM / 7 INCH		Ø330 MM / 13 INCH		QUANTITY PER BULK CASE
			Paper	Blister	Paper	Blister	
0201	0.3 ±0.03 mm	8 mm	15,000	---	50,000	---	---
0402	0.5 ±0.05 mm	8 mm	10,000	---	50,000	---	50,000
0603	0.8 ±0.1 mm	8 mm	4,000	---	15,000	---	15,000
0805	0.6 ±0.1 mm	8 mm	4,000	---	20,000	---	10,000
	0.8 / 0.85 ±0.1 mm	8 mm	4,000	---	15,000	---	8,000
	1.00 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	5,000
1206	0.6 ±0.1 mm	8 mm	4,000	---	20,000	---	---
	0.8 / 0.85 ±0.1 mm	8 mm	4,000	---	15,000	---	---
	1.00 / 1.15 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	---
	1.6 ±0.15 mm	8 mm	---	2,500	---	10,000	---
	1.6 ±0.2 mm	8 mm	---	2,000	---	8,000	---
1210	0.6 / 0.7 ±0.1 mm	8 mm	---	4,000	---	15,000	---
	0.85 ±0.1 mm	8 mm	---	4,000	---	10,000	---
	1.15 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.15 ±0.15 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	---	---
	1.5 ±0.1 mm	8 mm	---	2,000	---	---	---
	1.6 / 1.9 ±0.2 mm	8 mm	---	2,000	---	---	---
	2.0 ±0.2 mm	8 mm	---	2,000 1,000	---	---	---
1808	1.15 ±0.15 mm	12 mm	---	3,000	---	---	---
	1.25 ±0.2 mm	12 mm	---	3,000	---	---	---
	1.35 ±0.15 mm	12 mm	---	2,000	---	---	---
	1.5 ±0.1 mm	12 mm	---	2,000	---	---	---
	1.6 ±0.2 mm	12 mm	---	2,000	---	---	---
	2.0 ±0.2 mm	12 mm	---	2,000	---	---	---
	2.5 ±0.2 mm	8 mm	---	1,000 500	---	---	---
1812	0.6 / 0.85 ±0.1 mm	12 mm	---	2,000	---	---	---
	1.15 ±0.1 mm	12 mm	---	1,000	---	---	---
	1.15 ±0.15 mm	12 mm	---	1,000	---	---	---
	1.25 ±0.2 mm	12 mm	---	1,000	---	---	---
	1.35 ±0.15 mm	12 mm	---	1,000	---	---	---
	1.5 ±0.1 mm	12 mm	---	1,000	---	---	---
	1.6 ±0.2 mm	12 mm	---	1,000	---	---	---
	2.0 ±0.2 mm	12 mm	---	1,000	---	---	---
2.5 ±0.2 mm	12 mm	---	500	---	---	---	

**ELECTRICAL CHARACTERISTICS**
**NP0/X7R DIELECTRIC CAPACITORS; NISN TERMINATIONS**

Unless otherwise stated all electrical values apply at an ambient temperature of  $20 \pm 1$  °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

Table 6

DESCRIPTION		VALUE
Capacitance range		10 pF to 33 nF
Capacitance tolerance		
NP0	C < 10 pF	±0.25 pF, ±0.5 pF
	C ≥ 10 pF	±2%, ±5%
X7R		±5% <sup>(1)</sup> , ±10%
Dissipation factor (D.F.)		
NP0	C < 30 pF	≤ 1 / ( 400 + 20C )
	C ≥ 30 pF	≤ 0.1 %
X7R		≤ 2.5 %
Insulation resistance after 1 minute at $U_r$ (DC)		$R_{ins} \geq 10 \text{ G}\Omega$ or $R_{ins} \times C \geq 500$ seconds whichever is less
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient):		
NP0		±30 ppm/°C
X7R		±15%
Operating temperature range:		
NP0/X7R		-55 °C to +125 °C

**NOTE**

1. ±5% tolerance of capacitance value isn't available for X7R full product range, please contact local sales force before ordering

**HIGH-VOLTAGE NP0**

Sample limits (broken lines).  
Requirement levels (dotted lines)

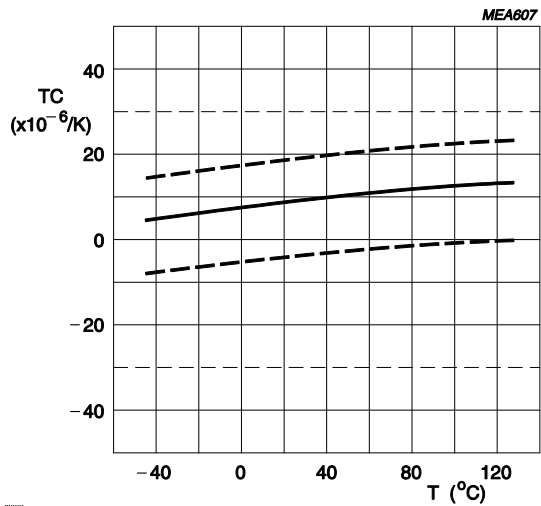


Fig. 3 Typical temperature coefficient as a function of temperature

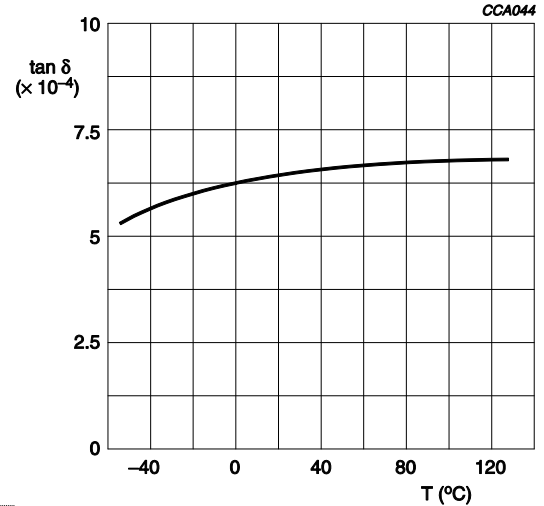


Fig. 4 Typical tan δ as a function of temperature

**HIGH-VOLTAGE X7R**

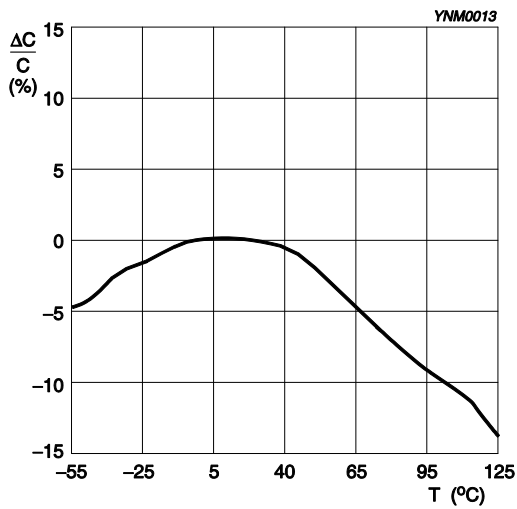


Fig. 5 Typical capacitance change as a function of temperature

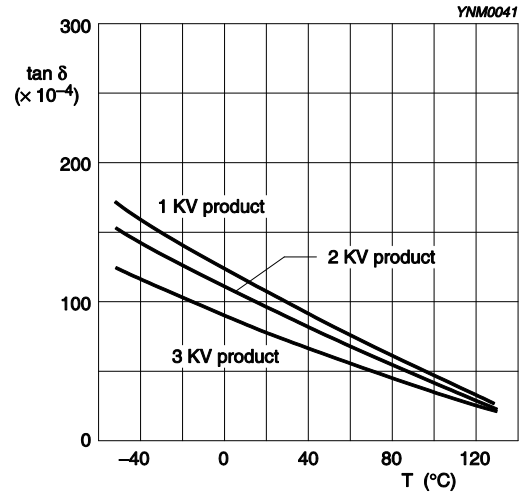


Fig. 6 Typical tan δ as a function of temperature



## SOLDERING RECOMMENDATION

Table 7

SOLDERING METHOD	SIZE				
	0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1 μF	≥ 1.0 μF	≥ 2.2 μF	≥ 4.7 μF	Reflow only
Reflow/Wave	< 0.1 μF	< 1.0 μF	< 2.2 μF	< 4.7 μF	---

## TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384-21/22 4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check	4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance	4.5.1	Class 1: f = 1 MHz for C ≤ 1 nF, measuring at voltage 1 V <sub>rms</sub> at 20 °C f = 1 KHz for C > 1 nF, measuring at voltage 1 V <sub>rms</sub> at 20 °C Class 2: f = 1 KHz for C ≤ 10 μF, measuring at voltage 1 V <sub>rms</sub> at 20 °C	Within specified tolerance
Dissipation Factor (D.F.)	4.5.2	Class 1: f = 1 MHz for C ≤ 1 nF, measuring at voltage 1 V <sub>rms</sub> at 20 °C f = 1 KHz for C > 1 nF, measuring at voltage 1 V <sub>rms</sub> at 20 °C Class 2: f = 1 KHz for C ≤ 10 μF, measuring at voltage 1 V <sub>rms</sub> at 20 °C	In accordance with specification
Insulation Resistance	4.5.3	U <sub>r</sub> ≤ 500 V: At U <sub>r</sub> for 1 minute U <sub>r</sub> > 500 V: At 500 V for 1 minute	In accordance with specification

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS									
Temperature Coefficient	4.6	Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage.	<General purpose series> Class I: $\Delta C/C: \pm 30\text{ppm}$  Class 2: X7R: $\Delta C/C: \pm 15\%$ Y5V: $\Delta C/C: 22\sim-82\%$  <High Capacitance series> Class 2: X7R/X5R: $\Delta C/C: \pm 15\%$ Y5V: $\Delta C/C: 22\sim-82\%$									
		<table border="1"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> </tr> </thead> <tbody> <tr> <td>a</td> <td>25±2</td> </tr> <tr> <td>b</td> <td>Lower temperature±3°C</td> </tr> <tr> <td>c</td> <td>25±2</td> </tr> <tr> <td>d</td> <td>Upper Temperature±2°C</td> </tr> <tr> <td>e</td> <td>25±2</td> </tr> </tbody> </table> <p>(1) Class I Temperature Coefficient shall be calculated from the formula as below  <math display="block">\text{Temp. Coefficient} = \frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}</math>                     C1: Capacitance at step c                      C2: Capacitance at 125°C  <math>\Delta T: 100^\circ\text{C}(=125^\circ\text{C}-25^\circ\text{C})</math></p> <p>(2) Class II Capacitance Change shall be calculated from the formula as below  <math display="block">\Delta C = \frac{C2 - C1}{C1} \times 100\%</math>                     C1: Capacitance at step c                      C2: Capacitance at step b or d</p>		Step	Temperature(°C)	a	25±2	b	Lower temperature±3°C	c	25±2	d
Step	Temperature(°C)											
a	25±2											
b	Lower temperature±3°C											
c	25±2											
d	Upper Temperature±2°C											
e	25±2											
Adhesion	IEC 60384-21/22	4.7 A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate	Force size $\geq 0603: 5\text{N}$									
Bending Strength		4.8 Mounting in accordance with IEC 60384-22 paragraph 4.3  Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 5 mm	No visible damage  $\Delta C/C$ Class 1: NP0: within $\pm 1\%$ or 0.5 pF, whichever is greater Class 2: X7R: $\pm 10\%$									

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Resistance to Soldering Heat	4.9	Precondition: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Preheating: for size ≤ 1206: 120 °C to 150 °C for 1 minute Preheating: for size >1206: 100 °C to 120 °C for 1 minute and 170 °C to 200 °C for 1 minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned <hr/> $\Delta C/C$ Class 1: NP0: within ±0.5% or 0.5 pF, whichever is greater Class2: X7R: ±10% <hr/> D.F. within initial specified value R <sub>ins</sub> within initial specified value
Solderability	4.10	Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.  1. Temperature: 235±5°C / Dipping time: 2 ±0.5 s 2. Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free)Depth of immersion: 10mm	The solder should cover over 95% of the critical area of each termination
Rapid Change of Temperature	IEC 60384-21/22 4.11	Preconditioning: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature  5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature  Recovery time 24 ±2 hours	No visual damage <hr/> $\Delta C/C$ Class 1: NP0: within ±1% or 1 pF, whichever is greater Class2: X7R: ±15% <hr/> D.F. meet initial specified value R <sub>ins</sub> meet initial specified value
Damp Heat	4.13	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Damp heat test: 500 ±12 hours at 40 ±2 °C; 90 to 95% R.H. 4. Recovery: Class 1: 6 to 24 hours Class 2: 24 ±2 hours 5. Final measure: C, D, IR  P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.	No visual damage after recovery <hr/> $\Delta C/C$ Class 1: NP0: within ±2% or 1 pF, whichever is greater Class2: X7R: ±15% D.F. Class 1: NP0: ≤ 2 × specified value Class2: X7R: ≥ 25 V: ≤ 5% R <sub>ins</sub> Class 1: NP0: ≥ 2,500 MΩ or R <sub>ins</sub> × C <sub>r</sub> ≥ 25s whichever is less Class2: X7R: ≥ 500 MΩ or R <sub>ins</sub> × C <sub>r</sub> ≥ 25s whichever is less

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Endurance	IEC 60384-21/22 4.14	<ol style="list-style-type: none"> <li>Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ± 1 hour at room temp</li> <li>Initial measure: Spec: refer to initial spec C, D, IR</li> <li>Endurance test: Temperature: NP0/X7R: 125 °C Specified stress voltage applied for 1,000 hours. High-Voltage series follows the stress conditions below: Applied 2.0 × U<sub>r</sub> for &lt; 500 V series Applied 1.3 × U<sub>r</sub> for 500 V, 630 V series Applied 1.2 × U<sub>r</sub> for 1 KV, 2 KV, 3 KV series</li> <li>Recovery time: 24 ± 2 hours</li> <li>Final measure: C, D, IR</li> </ol> <p>P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.</p>	No visual damage <hr/> ΔC/C Class1: NP0: within ±2% or 1 pF, whichever is greater Class2: X7R: ±15% D.F. Class1: NP0: ≤ 2 × specified value Class2: X7R: ≥ 25 V: ≤ 5% R <sub>ins</sub> Class1: NP0: ≥ 4,000 MΩ or R <sub>ins</sub> × C <sub>r</sub> ≥ 40s whichever is less Class2: X7R: ≥ 1,000 MΩ or R <sub>ins</sub> × C <sub>r</sub> ≥ 50s whichever is less
Voltage Proof		Specified stress voltage applied for 1~5 seconds U <sub>r</sub> ≤ 100 V: series applied 2.5 U <sub>r</sub> 100 V < U <sub>r</sub> ≤ 200 V series applied (1.5 U <sub>r</sub> + 100) 200 V < U <sub>r</sub> ≤ 500 V series applied (1.3 U <sub>r</sub> + 100) U <sub>r</sub> > 500 V: 1.3 U <sub>r</sub> U <sub>r</sub> ≥ 1KV: 1.2 U <sub>r</sub> Charge/Discharge current less than 50mA	No breakdown or flashover

**REVISION HISTORY**

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 8	Oct. 12, 2015	-	- <b>Product range updated</b>
Version 7	May 21, 2014	-	- <b>Product range updated</b>
Version 6	Jun. 17, 2012	-	- <b>Product range updated</b>
Version 5	Sep 25, 2012	-	- <b>Product range updated</b>
Version 4	Aug 08, 2011	-	- Product range updated
Version 3	Jan 19, 2011	-	- Dimension updated - Add NP0 0805 1KV
Version 2	Feb 02, 2010	-	- Change to dual brand datasheet that describe High-Voltage NP0/X7R series with RoHS compliant - Replace the high voltage part of pdf files: UP-NP0X7R_HV_1K-to-4KV_I and UY-NP0X7R_HV_1K-to-4KV_I - Description of "Halogen Free compliant" added - Product range updated - Define global part number - Test method and procedure updated
Version 1	Sep 30, 2005	-	- Thickness revised
Version 0	Sep 12, 2005	-	- New